

SAW RF filter for base stations CDMA 450

Series/type: B5365

Ordering code: B39451B5365U410

Date: May 05, 2016

Version: 2.0

© EPCOS AG 2016. Reproduction, publication and dissemination of this data sheet, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.



SAW RF filter for base stations

452.4 MHz

Data sheet

Table of contents

1 Application	3
2 Features	3
2 <u>Features</u>	4
4 <u>Pin configuration</u>	4
5 Matching circuit	5
6 Characteristics	6
7 Maximum ratings	7
8 Transmission coefficient.	8
9 Reflection coefficients.	
10 Packing material	10
11 Marking	12
12 Soldering profile	14
13 Annotations.	15
14 Cautions and warnings.	
Important notes.	



SAW RF filter for base stations

452.4 MHz

Data sheet

1 Application

- RF filter for CDMA 450
- Unblanced to unblanced operation
- Low amplitude ripple
- Usable pass band 4.8 MHz
- No matching required for operation

2 Features

- Package code DCC6C
- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)

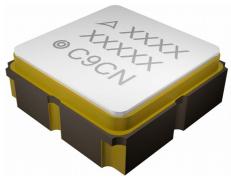


Figure 1: Picture of component with example of product marking.

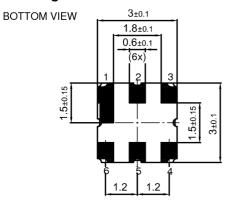


SAW RF filter for base stations

452.4 MHz

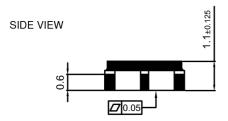
Data sheet

3 Package



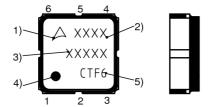
4 Pin configuration

- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground



TOP VIEW





- 1) Company logo
- 2) Device designation
- 3) Last five digits of the lot number
- 4) Marking for pad number 1
- 5) Example of production location and date code

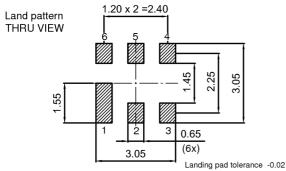


Figure 2: Drawing of package. See Sec. Package information (p. 16).



SAW components

B5365

SAW RF filter for base stations

452.4 MHz

Data sheet

5 Matching circuit

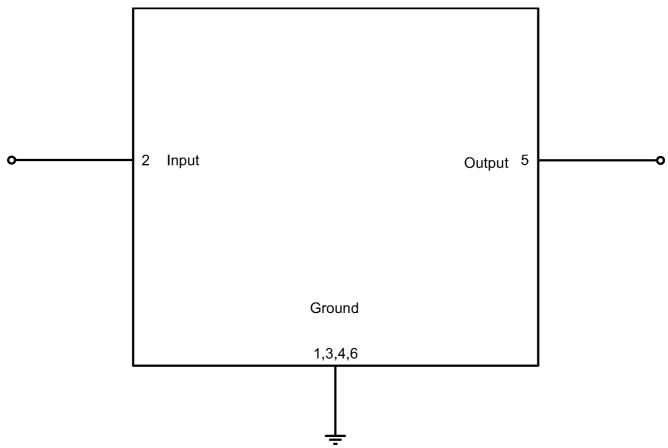


Figure 3: Schematic of matching circuit. No external matching components required.



SAW RF filter for base stations

452.4 MHz

Data sheet

6 Characteristics

Temperature range for specification
Input terminating impedance
Output terminating impedance

 $T_{\text{SPEC}} = -30 \, ^{\circ}\text{C} \dots +80 \, ^{\circ}\text{C}$

 $Z_{\text{IN}} = 50 \,\Omega$ $Z_{\text{OUT}} = 50 \,\Omega$

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	452.4	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	450 454.8	MHz		_	2.0	2.8	dB
Amplitude ripple (p-p)			Δα				
	450 454.8	MHz		_	0.8	1.8	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	450 454.8	MHz		_	1.5	2.0	
@ output port	450 454.8	MHz		_	1.5	2.0	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	0.3 440	MHz		25	36	_	dB
	460 464.8	MHz		30	40	_	dB
	464.8 1700	MHz		20	27	_	dB
	1700 2000	MHz		15	22	_	dB



SAW components

B5365

SAW RF filter for base stations

452.4 MHz

Data sheet

7 Maximum ratings

Operable temperature	T _{OP} = −45 °C +125 °C	
Storage temperature	T _{STG} = -45 °C +125 °C	
DC voltage	V _{DC} = 5.0 V	
ESD voltage	V _{ESD} = 150 V	



SAW RF filter for base stations

452.4 MHz

Data sheet

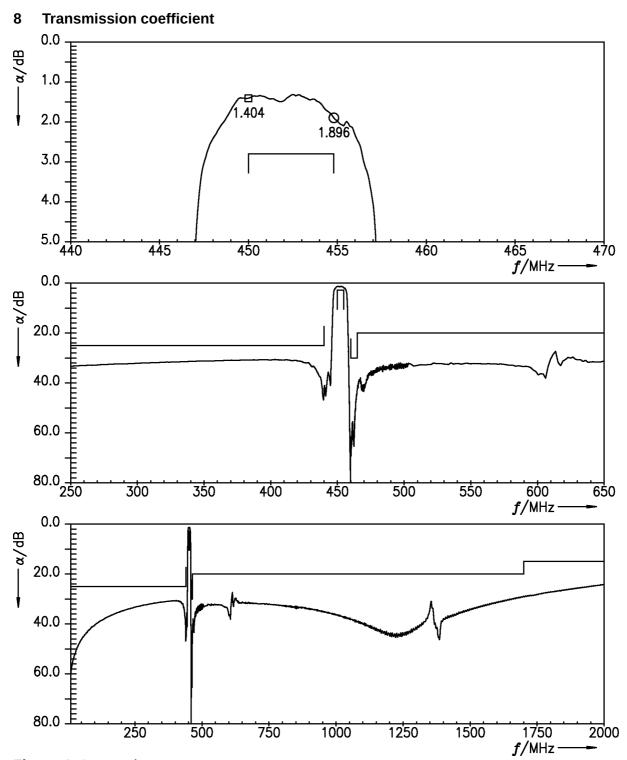


Figure 4: Attenuation.

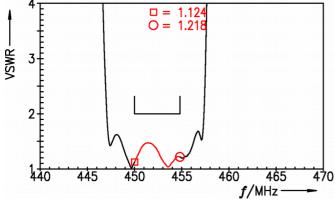


SAW RF filter for base stations

452.4 MHz

Data sheet

9 Reflection coefficients



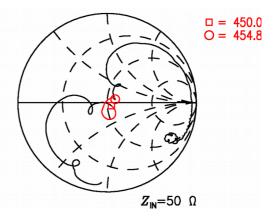
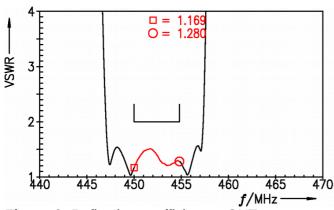


Figure 5: Reflection coefficient at IN port.



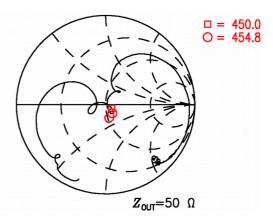


Figure 6: Reflection coefficient at OUT port.



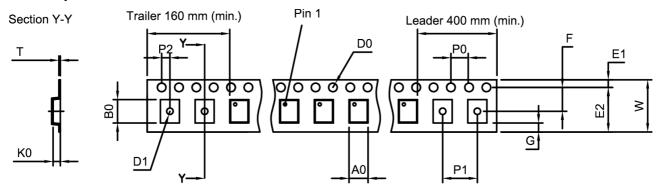
SAW RF filter for base stations

452.4 MHz

Data sheet

10 Packing material

10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	3.25±0.1 mm	Ξ ₂ 10.25 mm (mi	า.)	P ₁	4.0±0.1 mm
B ₀	3.3±0.1 mm	F 5.5±0.05 mm		P ₂	2.0±0.1 mm
D ₀	1.5+0.1/-0 mm	G 0.75 mm (min)	Т	0.2±0.05 mm
D_1	1.5 mm (min.)	√ 1.5±0.1 mm		W	12.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀ 4.0 _{±0.1} mm			

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

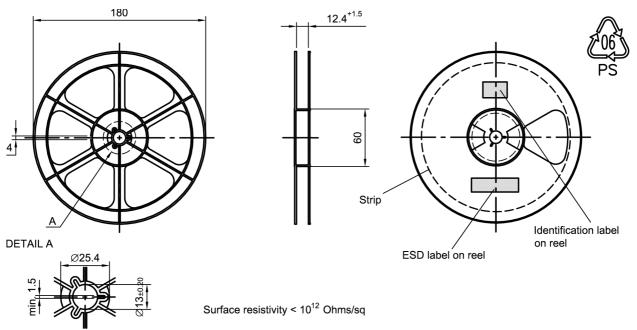


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.



SAW RF filter for base stations

452.4 MHz

Data sheet

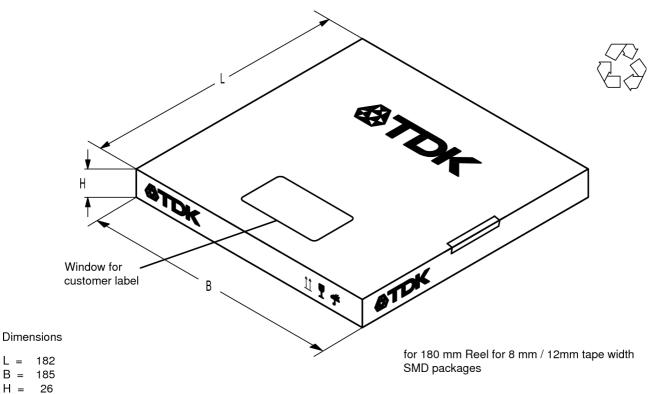


Figure 9: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

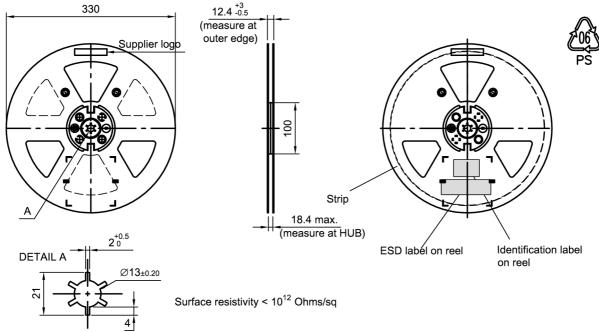


Figure 10: Drawing of reel (first-angle projection) with diameter of 330 mm.



SAW RF filter for base stations

452.4 MHz

Data sheet

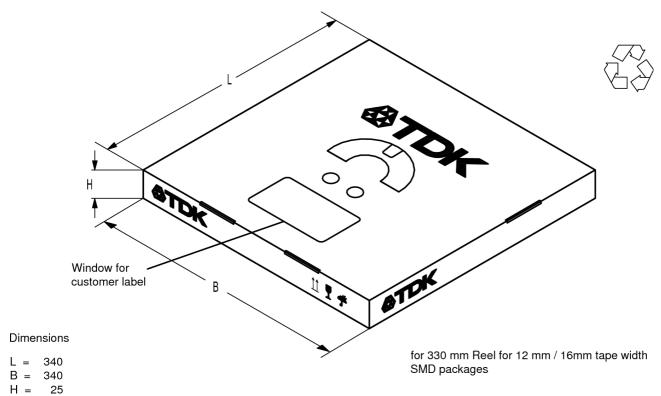


Figure 11: Drawing of folding box for reel with diameter of 330 mm.



SAW RF filter for base stations

452.4 MHz

Data sheet

11 Marking

Products are marked with device designation, lot number, as well as production location and date code.

■ Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: **12345**

■ Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

1 st digit (day)					2 nd digit (year)			3 rd digit (month)					
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 2: Production date code.

Example of how to decode production location and date code:

Code: CTF6

 $\begin{array}{ccccc} \text{Location:} & \text{C} & \rightarrow & \text{Wuxi} \\ \text{Day:} & \text{T} & \rightarrow & 26^{\text{th}} \\ \text{Year:} & \text{F} & \rightarrow & 2015 \\ \text{Month:} & 6 & \rightarrow & \text{June} \\ \end{array}$



SAW RF filter for base stations

452.4 MHz

Data sheet

12 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

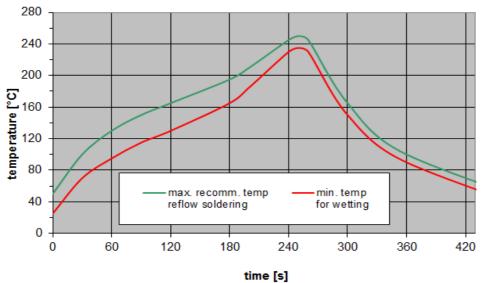


Figure 12: Recommended reflow profile for convection and infrared soldering – lead-free solder.



SAW RF filter for base stations

452.4 MHz

Data sheet

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.



SAW RF filter for base stations

452.4 MHz

Data sheet

14 Cautions and warnings

14.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.
 - The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- 7. The trade names EPCOS, Alu-X, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PQSine, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, TFAP, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.